**Features**

- n Interdigitated amplifying gates
- n Fast turn-on and high di/dt
- n Low switching losses

Typical Applications

- n Inductive heating
- n Electronic welders
- n Self-commutated inverters

Part No. Y60KKG-KT54cT

$I_{T(AV)}$	1500A
V_{DRM}, V_{RRM}	2000V 2200V
	2500V
t_q	25~70μs

SYMBOL	CHARACTERISTIC	TEST CONDITIONS	$T_j(^{\circ}C)$	VALUE			UNIT	
				Min	Type	Max		
$I_{T(AV)}$	Mean on-state current	180° half sine wave 50Hz Double side cooled	$T_c=55^{\circ}C$ 125			1500	A	
V_{DRM}/V_{RRM}	Repetitive peak off-state voltage	tp=10ms	125	2000		2500	V	
I_{DRM}/I_{RRM}	Repetitive peak current	at V_{DRM} at V_{RRM}	125			120	mA	
I_{TSM}	Surge on-state current	10ms half sine wave	125			16	kA	
I^2t	I^2t for fusing coordination	$V_R=0.6V_{RRM}$				1280	10^3A^2s	
V_{TO}	Threshold voltage		125			1.80	V	
r_T	On-state slope resistance					0.25	m Ω	
V_{TM}	Peak on-state voltage	$I_{TM}=3000A, F=28kN$	25			2.80	V	
dv/dt	Critical rate of rise of off-state voltage	$V_{DM}=0.67V_{DRM}$	125			1000	V/ μ s	
di/dt	Critical rate of rise of on-state current	$V_{DM}=67\%V_{DRM}$ Gate pulse $t_r \leq 0.5\mu s, I_{GM}=1.5A$	125			1200	A/ μ s	
Q_{rr}	Recovery charge	$I_{TM}=1000A, tp=4000\mu s,$ $di/dt=-20A/\mu s, V_R=100V$	125		600		μC	
t_q	Circuit commutated turn-off time	$I_{TM}=1000A, tp=4000\mu s, V_R=100V$ $dv/dt=30V/\mu s, di/dt=-20A/\mu s$	125	25		70	μs	
I_{GT}	Gate trigger current	$V_A=12V, I_A=1A$	25			40	mA	
V_{GT}	Gate trigger voltage					0.9	2.5	V
I_H	Holding current					20	500	mA
I_L	Latching current						1000	mA
V_{GD}	Non-trigger gate voltage			$V_{DM}=67\%V_{DRM}$	125			0.3
$R_{th(j-c)}$	Thermal resistance Junction to case	At 180° sine double side cooled				0.016	$^{\circ}C/W$	
$R_{th(c-h)}$	Thermal resistance case to heat sink	Clamping force 28.0kN				0.004		
F_m	Mounting force			27		34	kN	
T_{vj}	Junction temperature			-40		125	$^{\circ}C$	
T_{stg}	Stored temperature			-40		140	$^{\circ}C$	
W_t	Weight					640	g	
Outline	KT54cT							

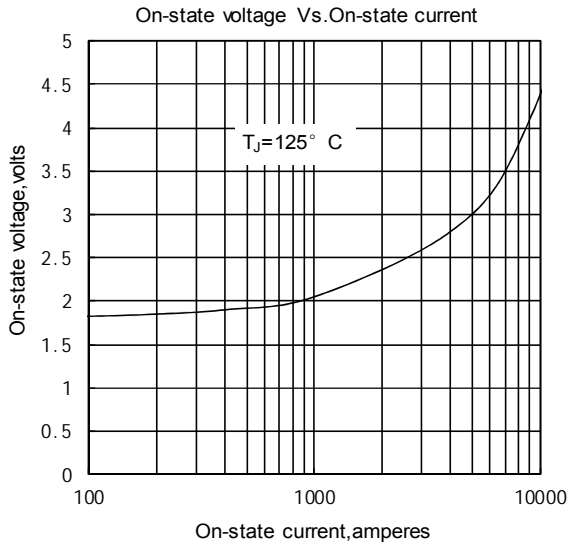


Fig.1

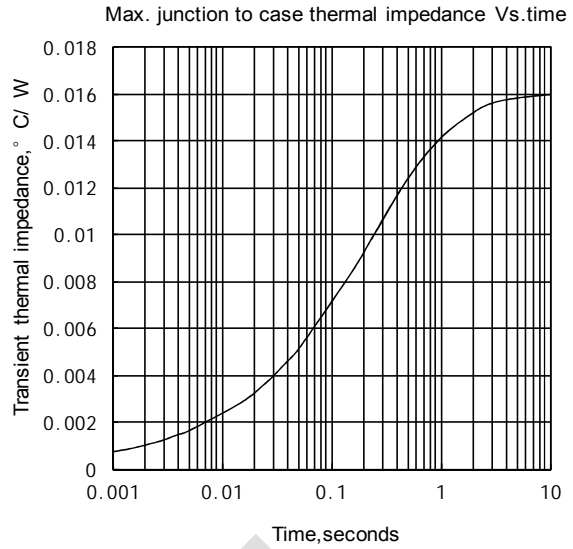


Fig.2

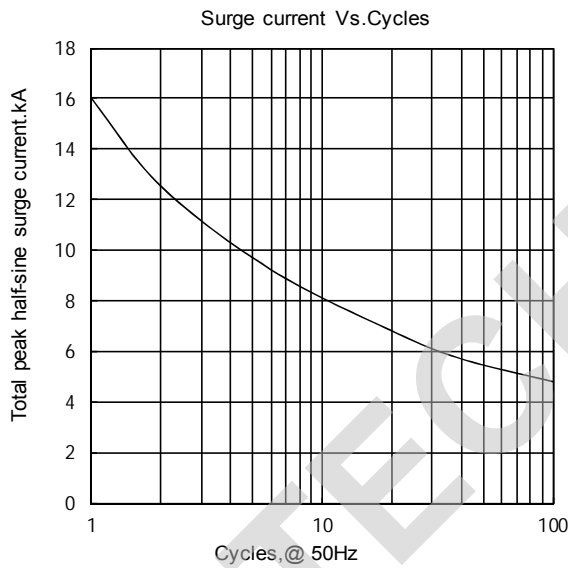


Fig.3

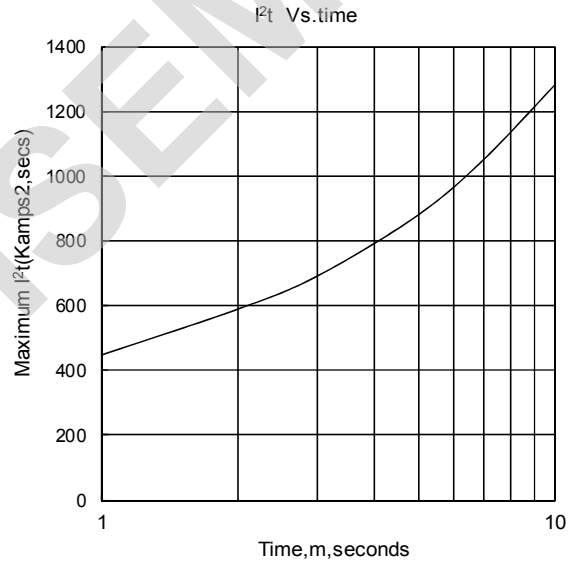


Fig.4

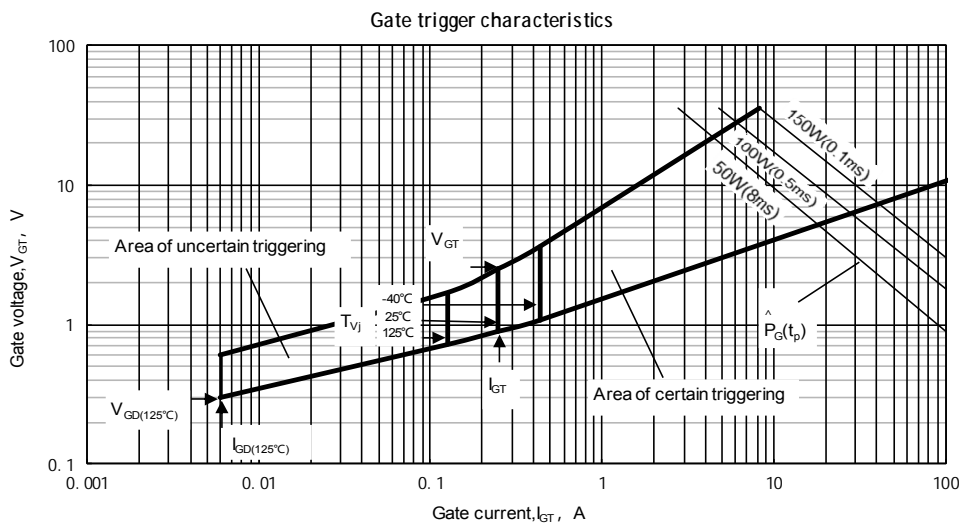
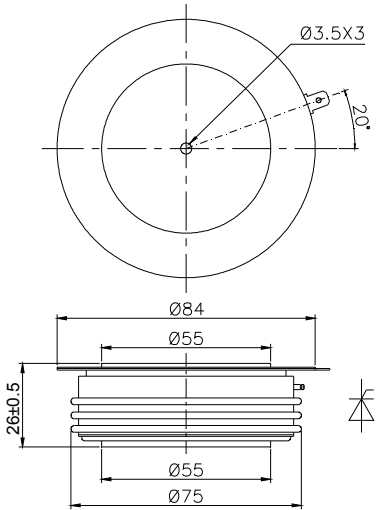


Fig.5

Outline:



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